

### DESCRIPTION

Electrical

The ML-7209 is a high-mu triode of the planar-electrode type designed for use as a grid- or plate-pulsed oscillator, switch tube, or frequency multiplier at frequencies up to 3 Gc. Features include low interelectrode capacitances, high transconductance and great mechanical strength. Lead inductances and rf losses are minimized by a compact, rugged coaxial construction, making the tube ideally suited to cavity type circuits as well as for parallel line operation. The cathode is an indirectly-heated, oxide-coated disc. The anode is forced-air cooled. The **ML-7209** is a direct replacement for the **ML-381** but is constructed to withstand more severe conditions of shock and vibration.

### GENERAL CHARACTERISTICS

Heater Voltage, AC or DC (See "Application Notes")	6.0±5%	v
Heater Current at 6.0 Volts	1.0	А
Heater Heating Time, minimum	60	sec
Amplification Factor, Cutoff	60	
Amplification Factor, Dynamic	100	
Transconductance (Ib=70 mA, Eb=600 V)	25000	$\mu$ mhos
Interelectrode Capacitances, without Heater Voltage		
Grid-Plate	2.01	pf
Grid-Cathode	6.60	pf
Plate-Cathode, maximum	.035	pf
Mechanical		
Mounting Position	Optional	
Type of Cooling	Forced-air	
Maximum Anode Temperature	200	°C
Net Weight	21⁄4	οz

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#### MAXIMUM RATINGS

## AND TYPICAL OPERATING CONDITIONS

### Grid-Pulsed or Plate-Pulsed RF Oscillator and Amplifier -- Class C

### Maximum Ratings, Absolute Values

Frequency	3	Gc
Plate Voltage		
Grid-Pulsed, DC	1.5	kV
Plate-Pulsed, Peak Pulse Supply	3.5	kv
DC Grid Voltage	-150	V
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	-750	v
Grid positive to cathode	250	v
Average Plate Current	10	mА
Average Grid Current	5	mА
Peak Plate Current	3	a
Average Plate Dissipation (Forced-Air Cooling)	35	W
Average Grid Dissipation	2	W
Pulse Duration	5	$\mu$ s†
Duty Factor	.0033	+

### Typical Operation, Plate-Pulsed RF Oscillator

Frequency	2.5	Gc
Filament Voltage	. 5.8	v
Pulse Duration	. 5	μs
Duty Factor	.0030	
Pulse Repetition Rate	. 660	pps
Peak Plate Pulse Supply Voltage	. 3.5	kv
DC Grid Voltage		v
Peak RF Plate Voltage	. 2.5	$\mathbf{k}\mathbf{v}$
Peak RF Grid Voltage	. 340	v
Peak Plate Current from Pulse Supply	. 3	а
Average Plate Current	. 9	mΑ
Average Grid Current	. 3	mΑ
Driving Power During Pulse, approximate	450	w
Useful Peak Power Output, approximate	2.2	kw

#### **Pulse Modulator or Pulse Amplifier**

Maximum Ratings, Absolute Values

DC Plate Voltage	1.5	kV
Peak Plate Voltage	1.8	kv
DC Grid Voltage	-150	V
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	-750	v
Grid positive to cathode	250	v
DC Plate Current	100	mА
Pulse Cathode Current	4.8	a
Average Plate Dissipation (Forced-Air Cooling)	100	W
Average Grid Dissipation	1.5	W
Pulse Duration	5	μs†
Duty Factor	.0033	+

### Frequency Doubler - Class C Telegraphy

#### Maximum Ratings, Absolute Values

Frequency	3	Gc
Peak Plate Pulse Supply Voltage	3.5	kv
Grid Bias Voltage (from cathode resistor)	-200	v
Instantaneous Peak Grid-Cathode Voltage		
Grid negative to cathode	750	v
Grid positive to cathode	250	v
Peak Cathode Current	3	a
Average Plate Current	6.5	mА
Average Grid Current	2	mΑ
Average Plate Input	25	W
Average Plate Dissipation (Forced-Air Cooling)	25	W
Average Grid Dissipation	1	W
Pulse Duration	5	μst
Duty Factor	.0033	+

### Typical Operation, Frequency Doubler

Frequency	.6 to 1.2	Gc
Filament Voltage	5.5	v
Pulse Duration	3	μs
Duty Factor	.0030	
Peak Plate Pulse Supply Voltage	3.5	kv
Grid Bias Voltage (from cathode resistor)	-190	v
Cathode Resistor	160	ohms
Peak Plate Current	1.2	a
Average Plate Dissipation	9	W
Driving Power During Pulse, approximate	600	w
Useful Power Output at Peak of Pulse, approx.	1.2	kw

+For applications requiring longer pulse duration or higher duty factors, consult the Machlett Engineering Department

### CHARACTERISTIC RANGE VALUES FOR EQUIPMENT DESIGN

	Min.	Max.	
Filament Current at 6.0 volts (Note 1)	0.90	1.05	А
Plate Current (Note 2)	60	95	mAdc
Cut-off Bias (Note 3)	—	-15	Vdc
Transconductance	0,000	30,000	μmhos
Grid-Plate Capacitance (Note 4)	1.86	2.16	pf
Grid-Cathode Capacitance (Note 4)	5.60	7.00	pf
Plate-Cathode Capacitance (Note 4)	—	.035	pf
Plate Tuning Range (Note 5)	1.98	2.02	Gc

- Note 1 For reduced filament voltage see "Heater Voltage" section under "Application Notes".
- Note 2 Measure at a plate voltage of 600 volts and a cathodebias resistor of 30 ohms.
- Note 3 Measured at 1 mA of plate current and a plate voltage of 600 volts.
- Note 4 Capacitance measurements are with the tube cold. When the filament is heated to proper operating temperature the grid-cathode capacitance will increase by about 1 pf due to thermal expansion of the cathode.
- Note 5 With a plate-grid coaxial cavity of fixed dimensions, all tubes will resonate within the specified frequency range.

### **APPLICATION NOTES**

Before designing equipment for use with these tubes and before installing tubes in equipment, refer to the general information given in the Machlett publication entitled Application Notes, UHF Tubes — General.





DIMENSIONS	FOR
OUTLINE (INC	HES)

Ref.	Minimum	Maximum
A	1.815	1.875
В	_	1.534
С		1.475
D	1.289	1.329
F	_	.980
G	.462	.477
н	-	.040
1	.125	.185
L	.766	.826
к	.025	.046
L	1.234	1.264
M	1.180	1.195
N	1.025	1.035
Р		.812
R	.655	.665
s	_	.545
T	.213	.223
υ	.315	.325
v	-	.086
w		.100
x		.035
Y	.105	.145
Z	.650	.850

#### NOTES

- a. The total indicated runout of the anode contact surface with respect to the cathode contact surface will not exceed .020 inch.
- b. The total indicated runout of the cathode contact surface with respect to the heater contact surface will not exceed .012 inch.
- c. The total indicated runout of the grid contact surface with respect to the cathode contact surface will not exceed .020 inch.
- k. Do not clamp or locate on this surface.
- m. Hole provided for tube extractor through top fin only.
- n. Measure anode shank temperature here.

#### DIMENSIONS FOR ELECTRODE CONTACT AREA (INCHES)

Ref.	Dimensions	Contact
AA	0.198 ± 0.163	Anode
AB	1.225 ± .040	Grid
AC	1.631 <u>±</u> .097	Heater
AD	1.645 🛨 .170	Cathode

DIMENSIONS-ML-7209

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